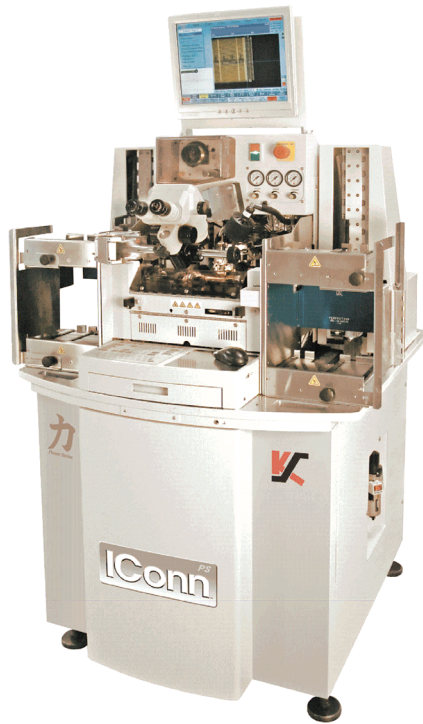


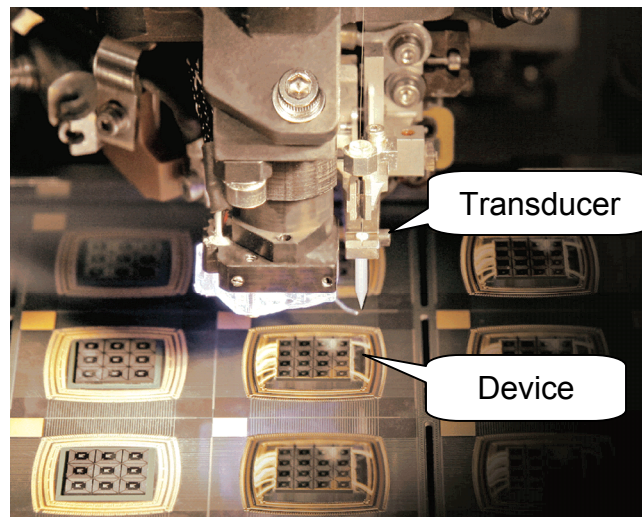


# Optimizing Piezoelectric Crystal Preload in Ultrasonic Transducers

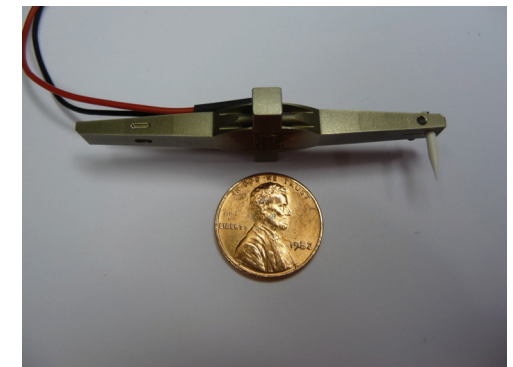
*Dominick A. DeAngelis  
And  
Gary W. Schulze*



Kulicke & Soffa's Flagship  
Semiconductor  
Wire Bonding Machine



Wire Bonding in Action with Fine  
Gold Wire (20 Wires/Sec)



Ultrasonic Transducer Used For  
Wire Bonding Machine

# OUTLINE

- ❖ Motivation for the Work
- ❖ Specific Transducer Application
- ❖ Research Summary
- ❖ Experimental Methods & Metrics
- ❖ Electromechanical Coupling
- ❖ Equivalent Circuits
- ❖ Bode Plot & Admittance Loop
- ❖ Experimental Results
- ❖ Conclusions
- ❖ References
- ❖ Questions





# MOTIVATION FOR THE WORK

- ❖ Preload is Required to Maintain the Piezo Stack in Compression
- ❖ Most Often Integral Piezo Crystals Used as Force Sensor for Preload
- ❖ A Press Fixture w/ Charge Amp Measures Voltage vs. Force
- ❖ Method Inaccurate Since Crystal Properties Can Vary  $\pm 20\%$  Lot-to-Lot
- ❖ Vendor Preload Guidelines Based on Static Crystal Testing Only
- ❖ Designers Often Struggle to Determine/Control Optimal Preload Level
- ❖ Transducer Based Methods and Metrics are Needed



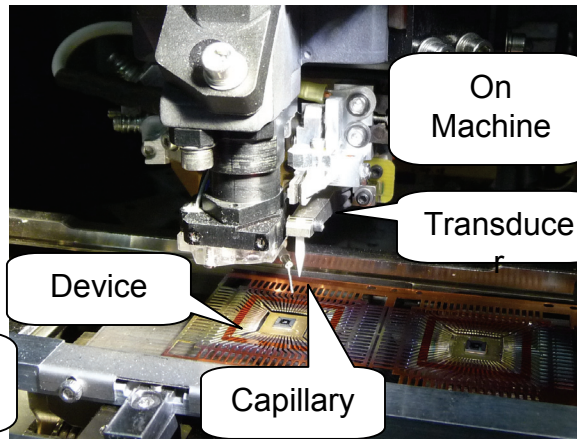
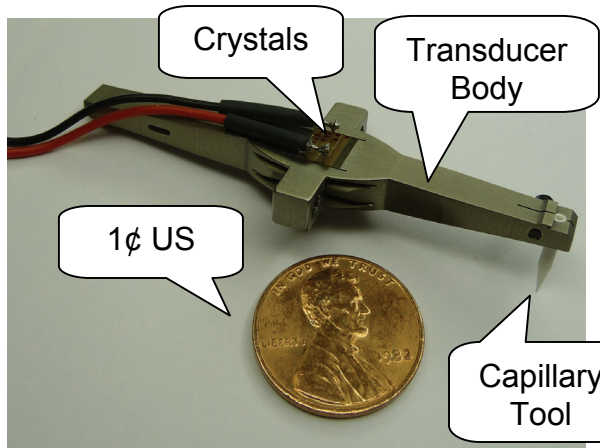
# MOTIVATION CON'T

## Why is Controlling Preload So Important?

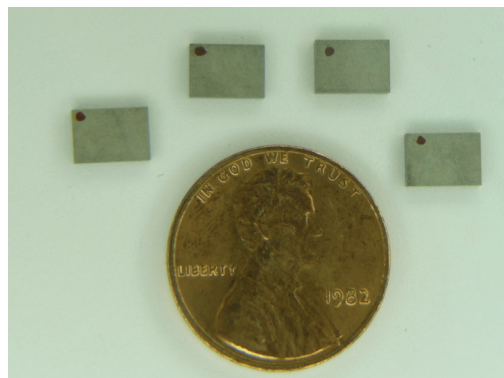
- ❖ Inadequate Preload Results in Dynamic Gapping at Interfaces
- ❖ Dynamic Gapping Manifests as Higher Impedance, Heating, Etc.
- ❖ Inadequate Preload Results in Prolonged Stress-Aging Affects
- ❖ Excessive Preload Results in Pronounced Depolling
- ❖ Excessive Preload Produces Unstable Impedance and Aging with Use

# SPECIFIC TRANSDUCER APPLICATION

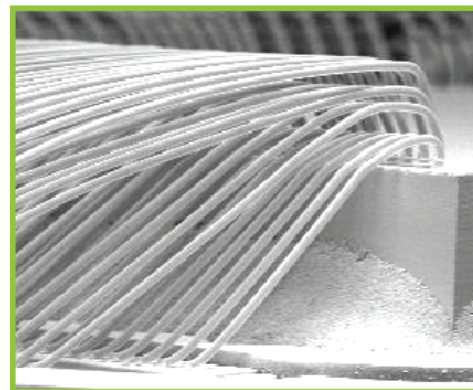
- ❖ K&S is the Leading MFG of Semiconductor Wire Bonding Equipment
- ❖ Transducer Delivers Energy to a Capillary Tool for Welding Tiny Gold Wires
- ❖ Patented Single Piece “Unibody” Transducer Design Ideal for Preload Study
- ❖ Portability Across 100’s of Machines Required for Same Customer Device



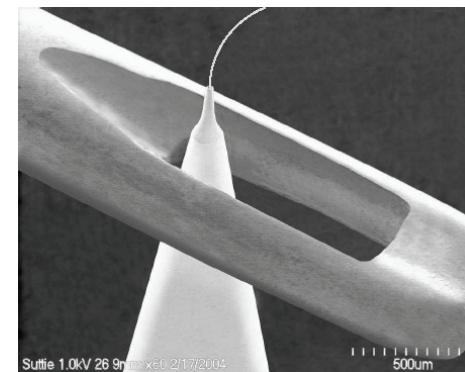
Transducer Specs  
 500 mA Max Current  
 120 kHz Operating Mode  
 80 Ohm Max Impedance  
 Operation 40 Bonds/Sec  
 Bond Duration ~10mSec  
 PZT8 Crystals (4X)



PZT8 Piezoelectric Crystals



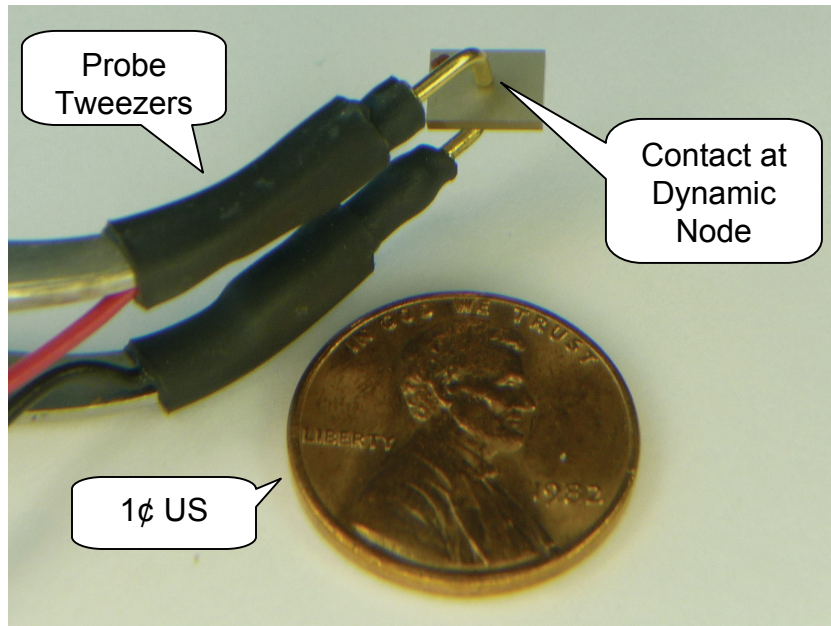
Actual Wire Bonds From  
 of a Multi-Tier Package



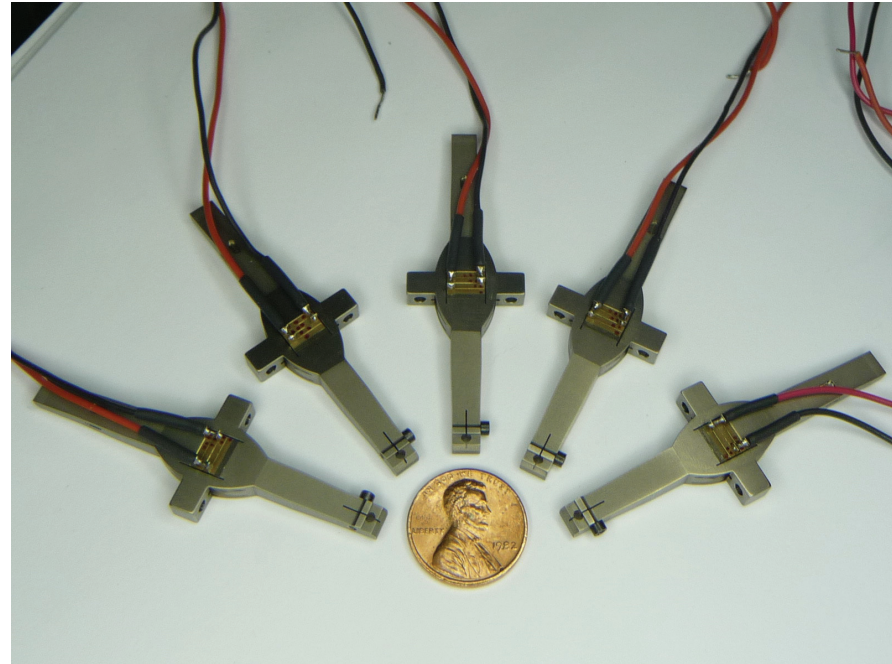
Typical Capillary Tool with Wire  
 Compared to Sewing Needle

# RESEARCH SUMMARY

- ❖ Five Transducers Built at Various Preload Levels from 4.5 ksi to 18 ksi
- ❖ All 5X Transducers Bodies and 20X Crystals from Same Production Lot
- ❖ Experimental Methods were Both Crystal and Transducer Based
- ❖ Transducers Subjected to Stabilizing Heat-Treatment & Cycling After Build



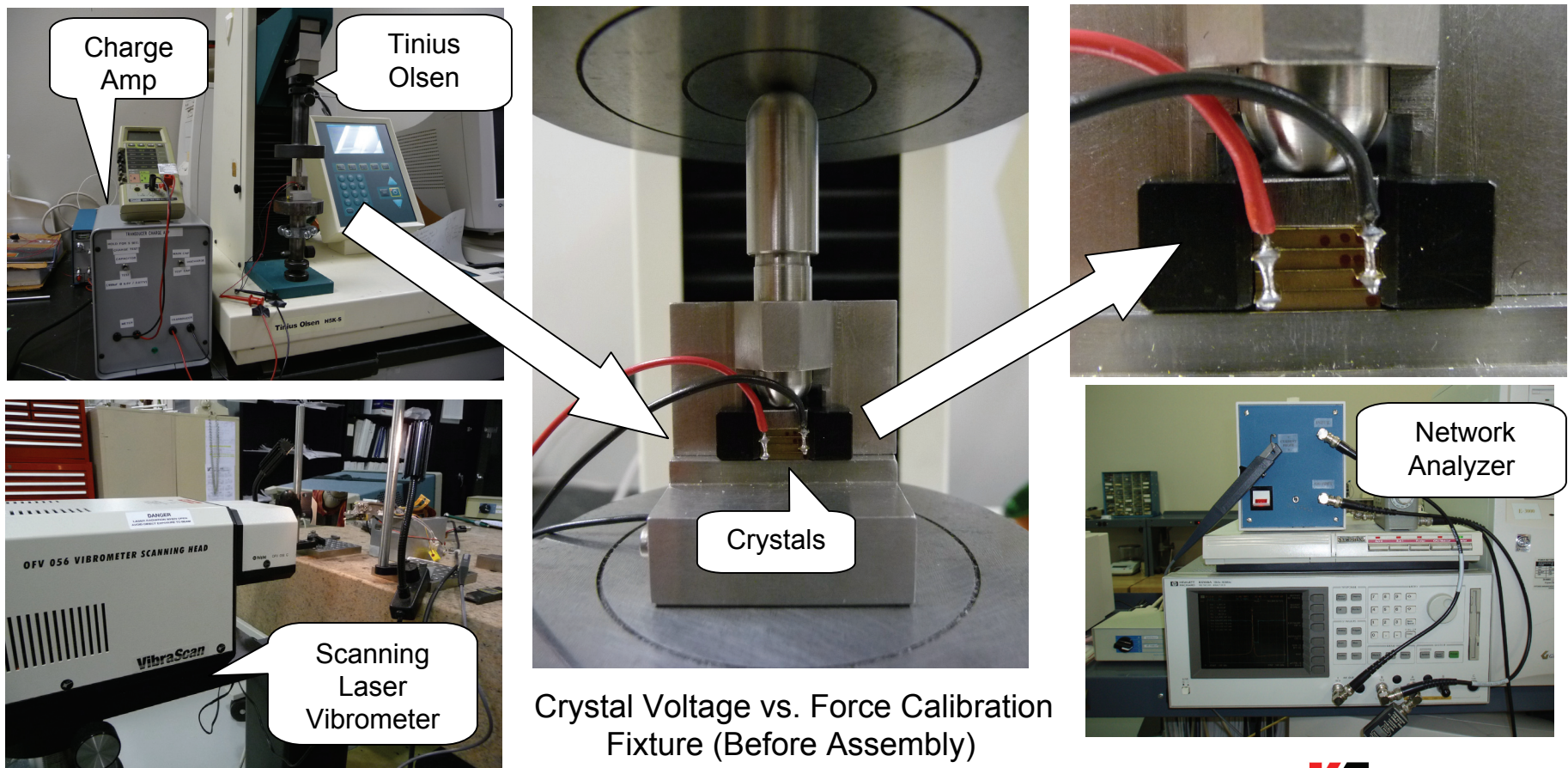
Crystal Based Bode Plot Technique



The Five Transducers Build for the Study

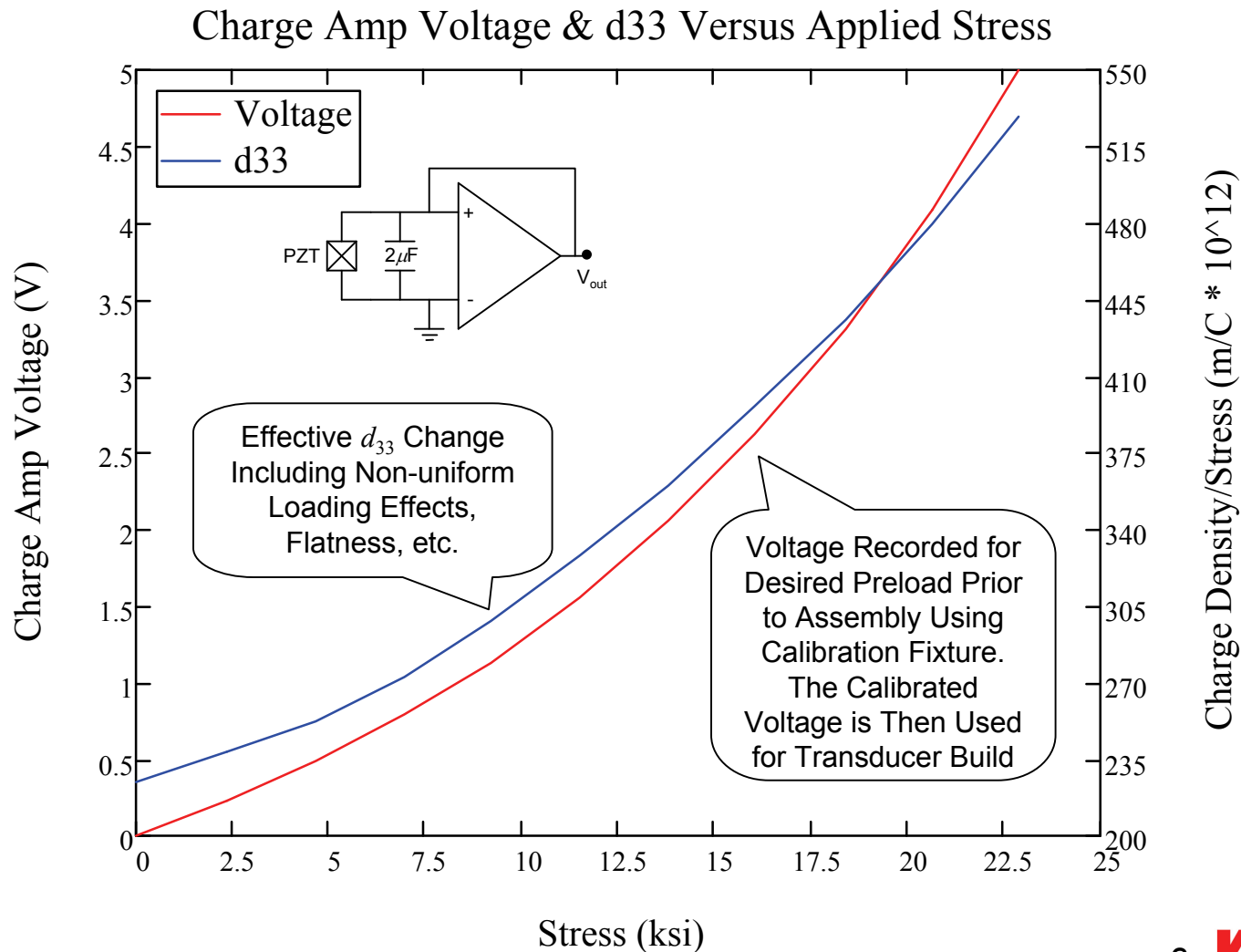
# EXPERIMENTAL METHODS & METRICS

- ❖ Bode Plots, Cap, DF of Individual Crystals Before Build
- ❖ Calibrated Stack Voltage vs. Force Prior to Assembly
- ❖ Bode Plots, Cap, DF of Transducer After Build and Heat-Treat
- ❖ Laser Vibrometer Gain Measurements After Heat-Treatment & Cycling



# METHODS & METRICS CON'T

- ❖ Results from Voltage vs. Force Calibration Fixture
- ❖ Piezoelectric Constant  $d_{33}$  Increases with Applied Stress

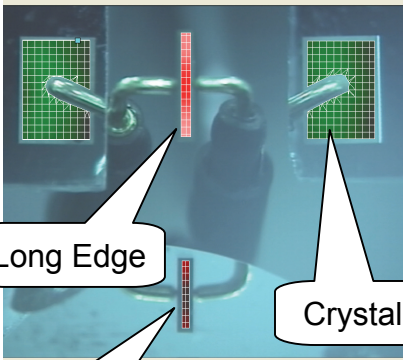




# METHODS & METRICS CON'T

- ❖ Crystal Laser Vibrometry and Finite Element Analysis
- ❖ Measured Out-of-Plane Motion From In-plane Structural Vibration (Poisson Effect)

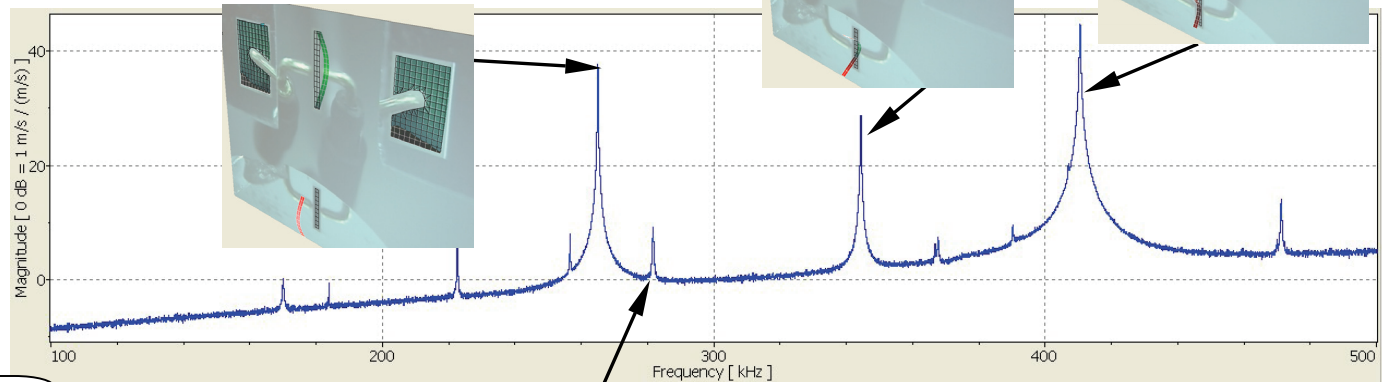
Single Crystal Vibrometer Setup (3X Mirrors)



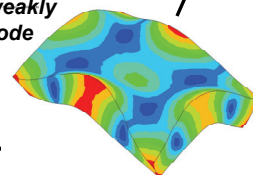
Long Edge

Crystal Face

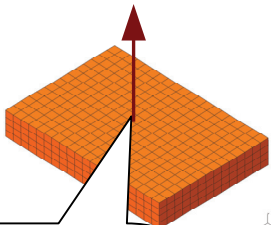
Short Edge



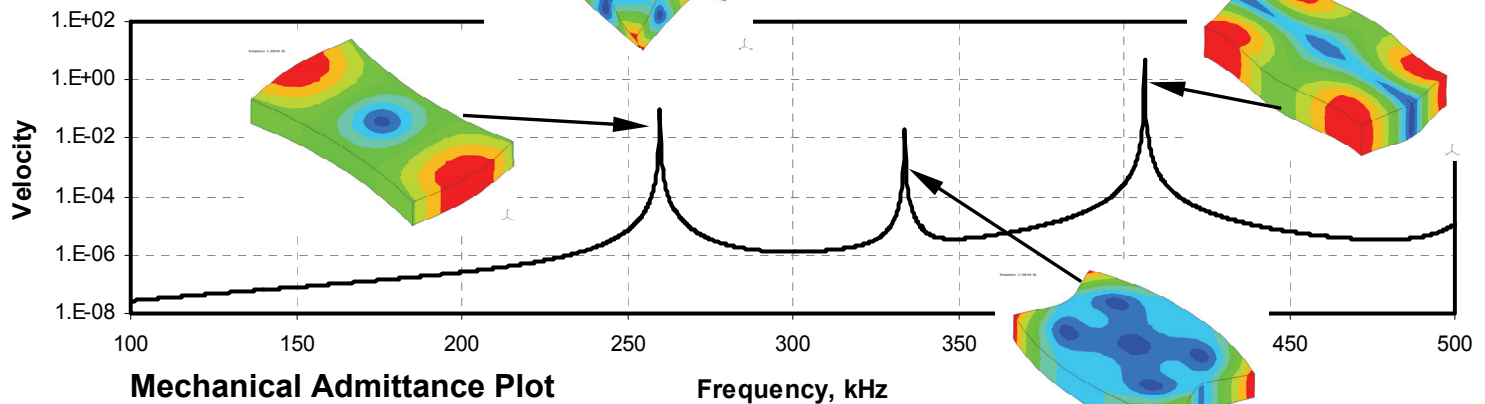
Example of weakly coupled mode



Finite Element Model



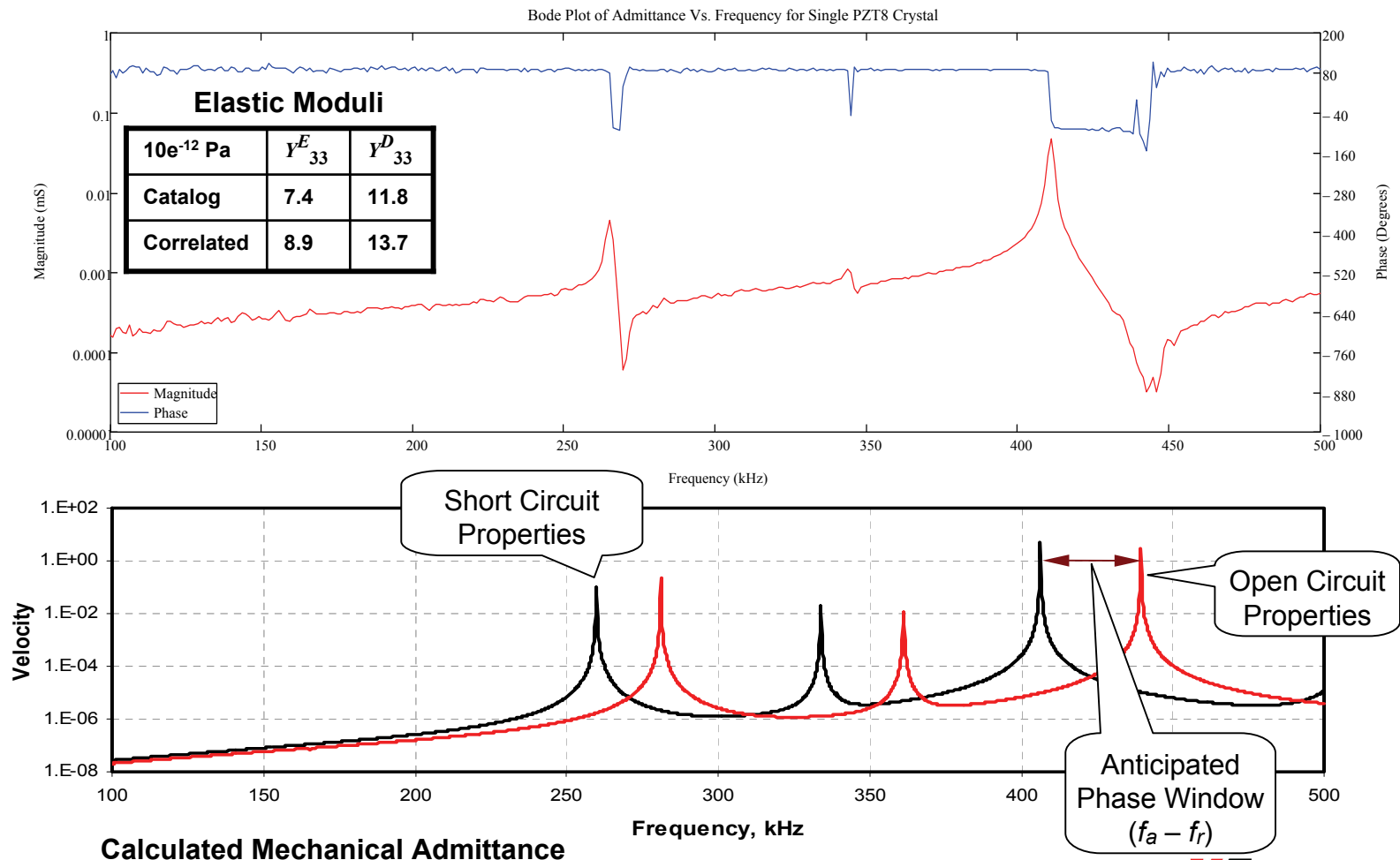
Excitation and Velocity Direction



# METHODS & METRICS CON'T

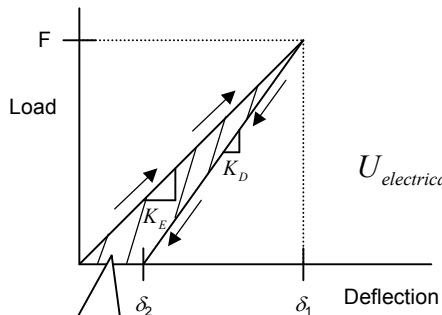
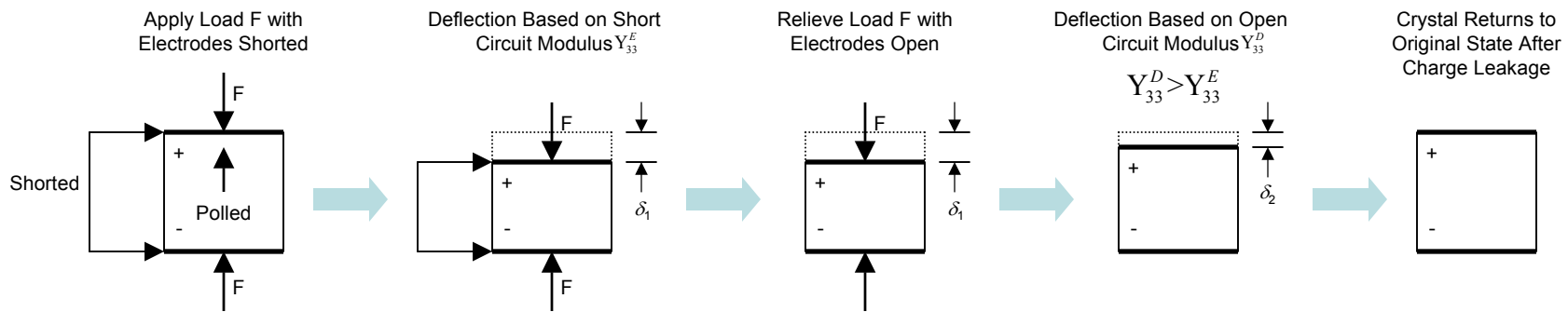
- ❖ Bode Plot and Corresponding Finite Element Admittance
- ❖ Single Crystal Analysis Demonstrates Short and Open Circuit Properties

Typical Bode Plot of Admittance Vs. Frequency of Single PZT8 Crystal



# ELECTROMECHANICAL COUPLING $k_{33}$

- ❖  $k_{33}$  Varies Proportionally to  $d_{33}$ , But Inversely to Square Root of Permittivity
- ❖  $k_{33}$  Varies Proportionally to Delta Between Open and Short Circuit Moduli



$$U_{mechanical} = \frac{1}{2} K_E \delta_1^2 - \frac{1}{2} K_D (\delta_1 - \delta_2)^2$$

$$K_D = Y_{33}^D \frac{Area}{Thickness}$$

$$K_E = Y_{33}^E \frac{Area}{Thickness}$$

$$U_{electrical} = \frac{1}{2} CV^2$$

$$C = \epsilon_{33}^T \frac{Area}{Thickness}$$

$$V = \frac{F}{d_{33} K_D}$$

$$k_{33} = \sqrt{\frac{Electrical\ Energy\ Stored}{Mechanical\ Energy\ Supplied}} = \sqrt{\frac{U_{electrical}}{U_{mechanical}}}$$

$$k_{33} = d_{33} Y_{33}^D \sqrt{\frac{Y_{33}^D - Y_{33}^E}{Y_{33}^E \epsilon_{33}^T}}$$

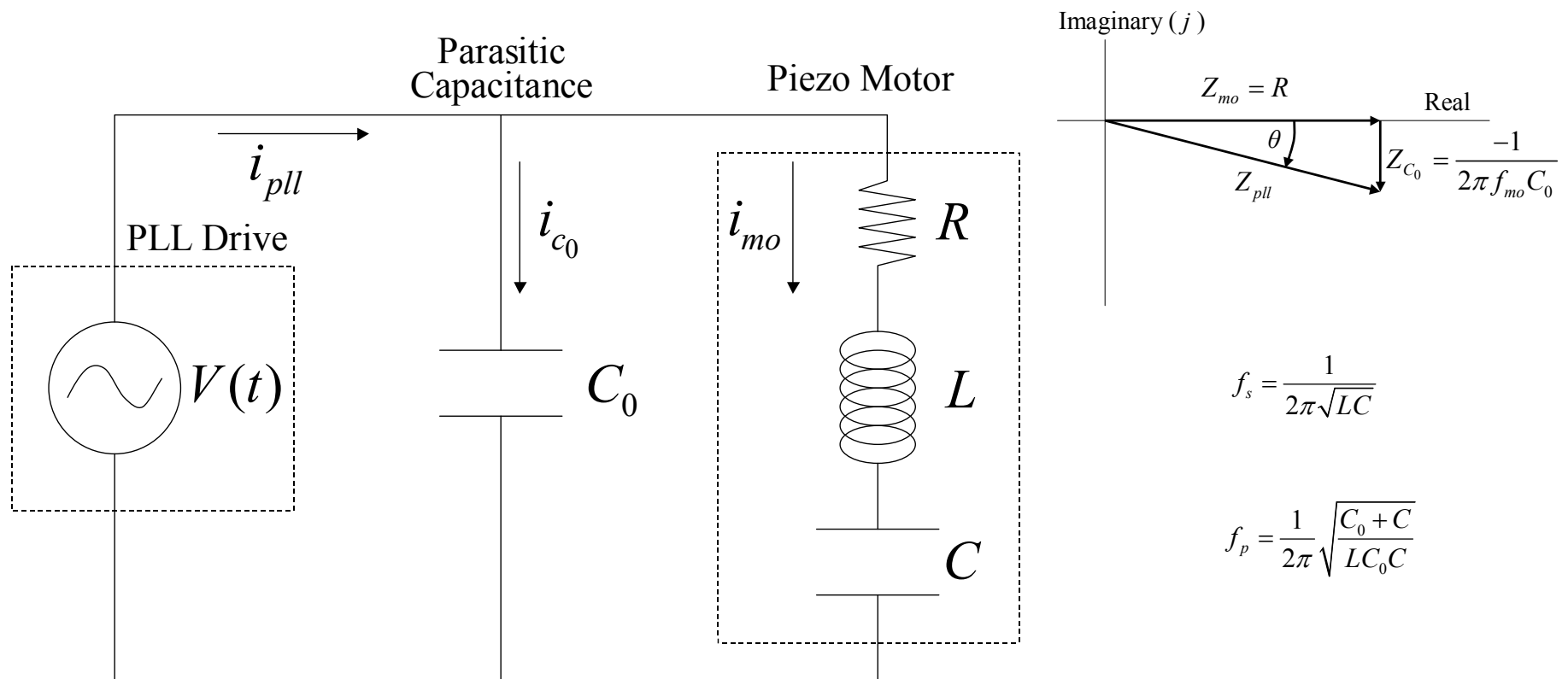
$$k_{33} = .63 \text{ (PZT8)}$$

Proportional

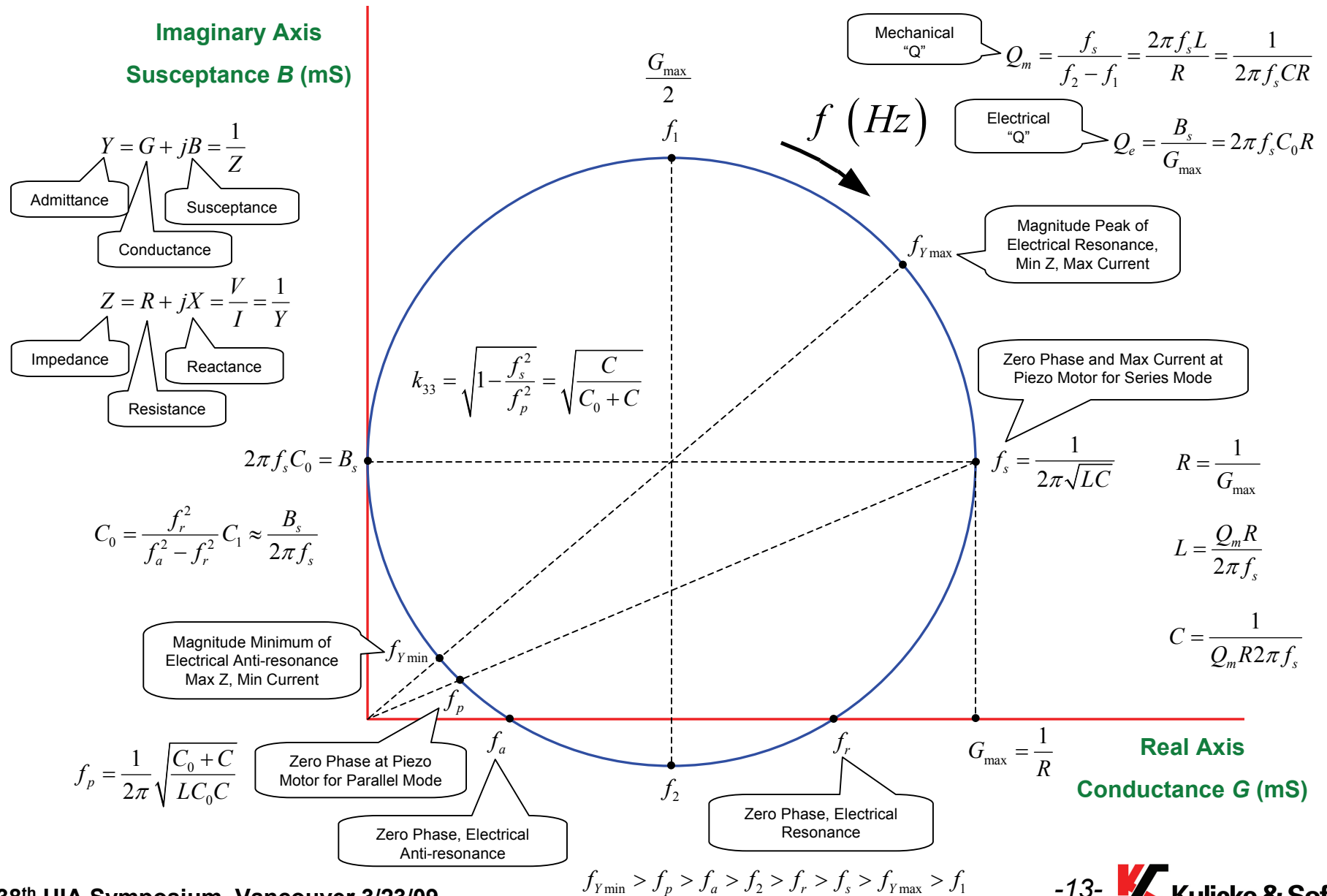
Inversely

# EQUIVALENT CIRCUITS

- ❖ For  $f_s$  Series Resonance  $i_{pll} \approx i_{mo}$  and  $i_{pll} \gg i_{co}$  (Via Short Circuit Modulus)
- ❖ For  $f_p$  Parallel Resonance  $i_{co} \approx -i_{mo}$  and  $i_{pll} \ll i_{mo}$  (Via Open Circuit Modulus)
- ❖ Spacing of  $f_p - f_s$  Proportional to Delta Between  $Y_{33}^D - Y_{33}^E$  (And  $k_{33}$  Too)

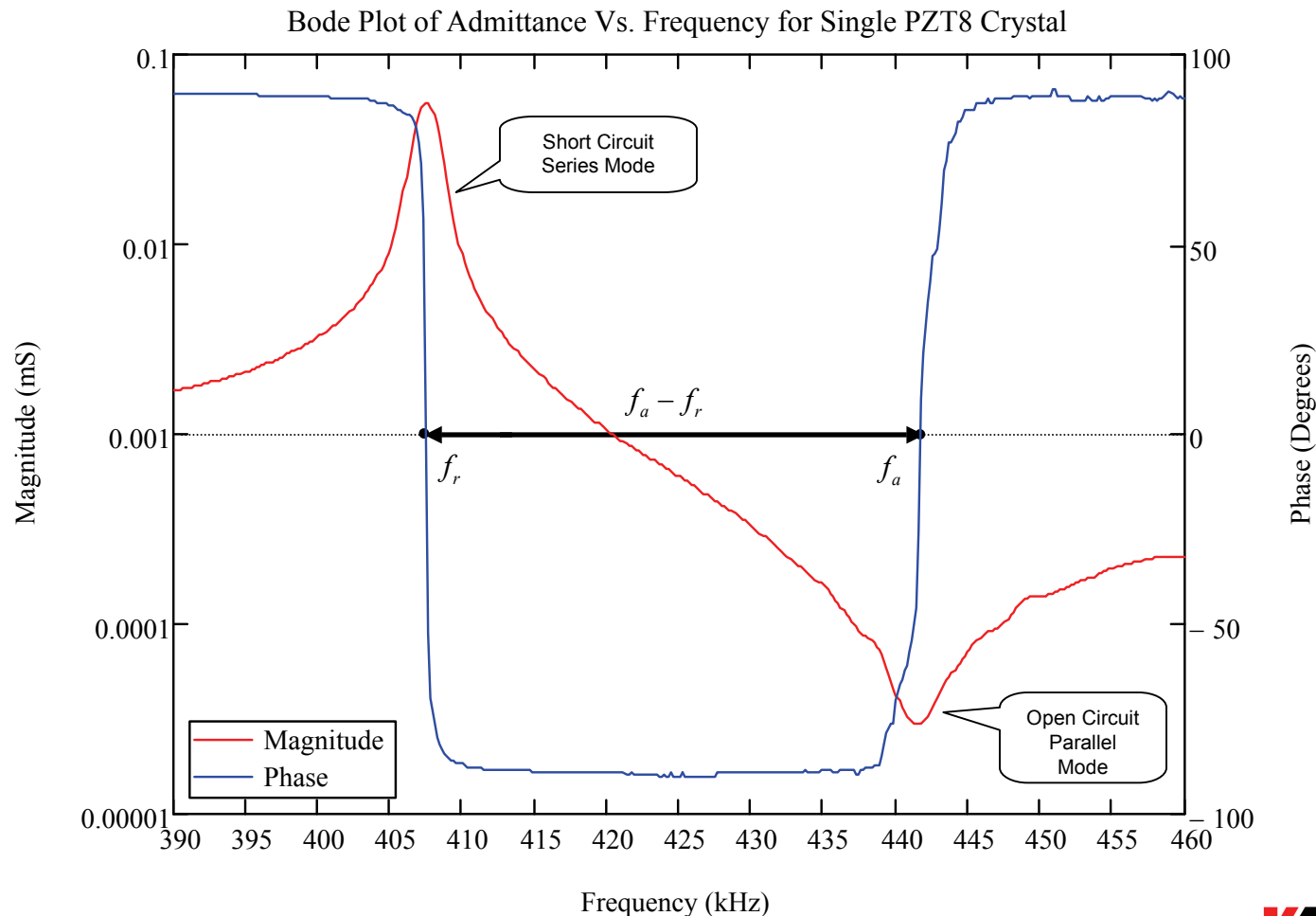


# ADMITTANCE (Y) LOOP



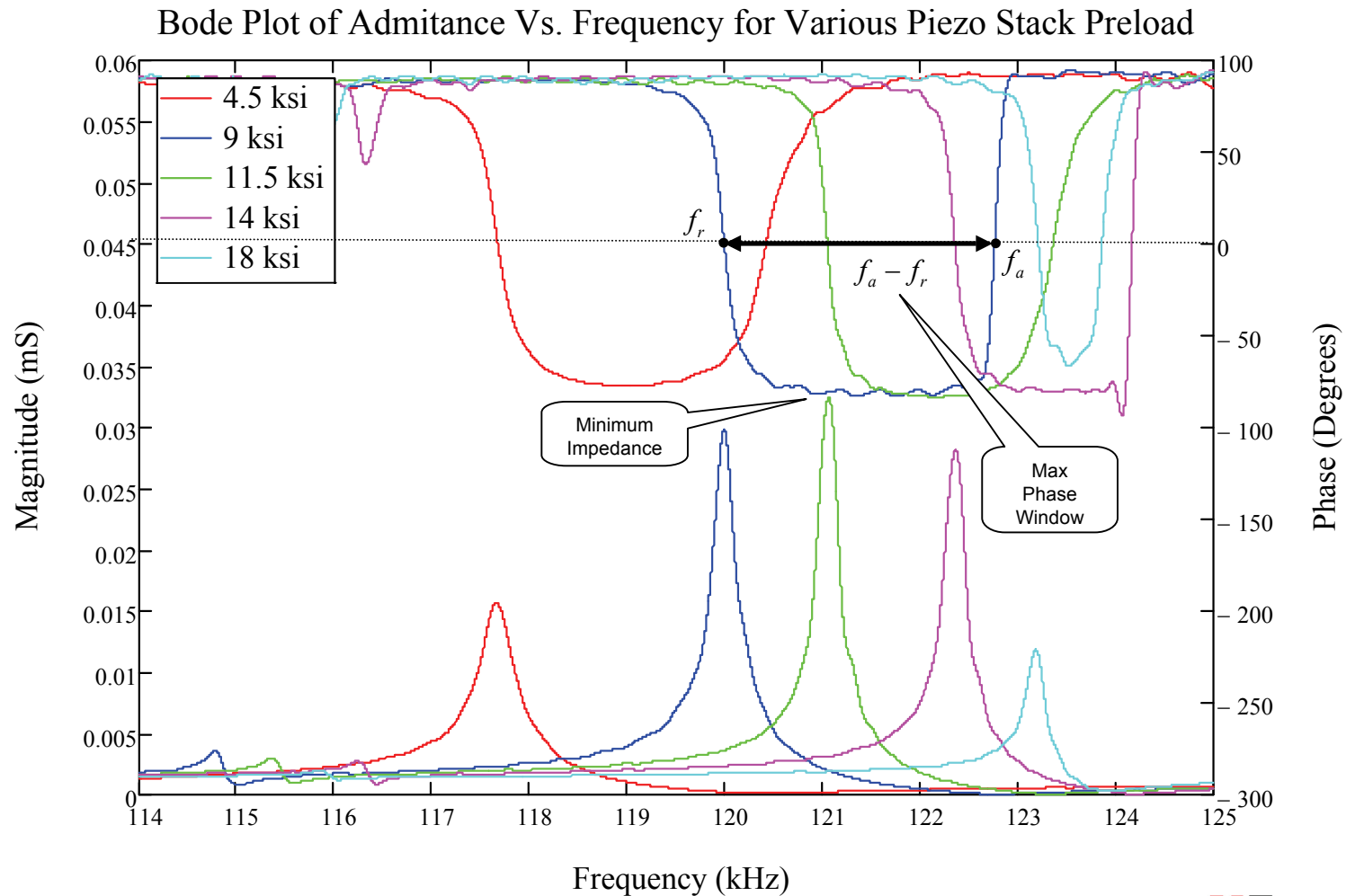
# EXPERIMENTAL RESULTS

- ❖ Typical Single Free-Free Crystal Bode Plot Results Prior to Build
- ❖  $k_{33}$  Proportional to Phase Window  $f_a - f_r$  (Similar for All Crystals)
- ❖ Dissipation Factor DF was .004 for All Crystals ( $\text{Tan}\delta$ )



# EXPERIMENTAL RESULTS CON'T

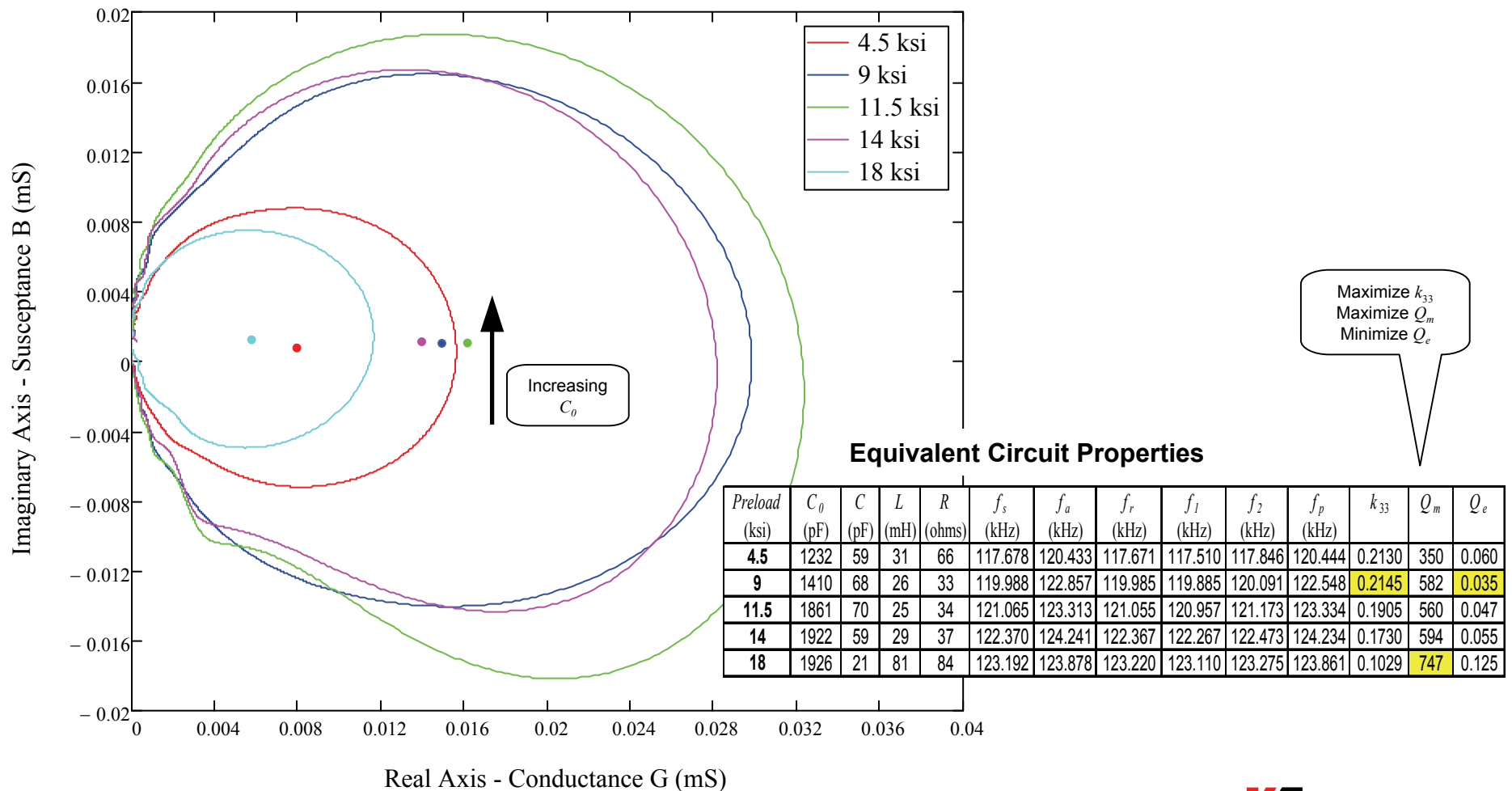
- ❖ Transducer Bode Plot Results After Stabilizing Heat-Treatment
- ❖  $k_{33}$  Proportional to Phase Window  $f_a - f_r$



# EXPERIMENTAL RESULTS CON'T

- ❖ Transducer Admittance Loop Bode Results After Stabilizing HT
- ❖ Find Preload that Maximizes  $k_{33}$  and  $Q_m$ , but Minimizes  $Q_e$

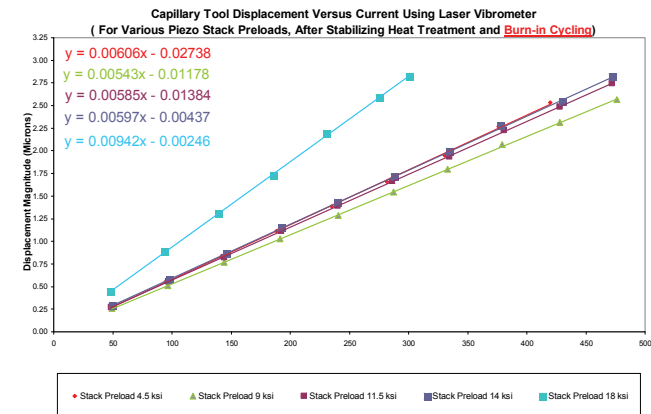
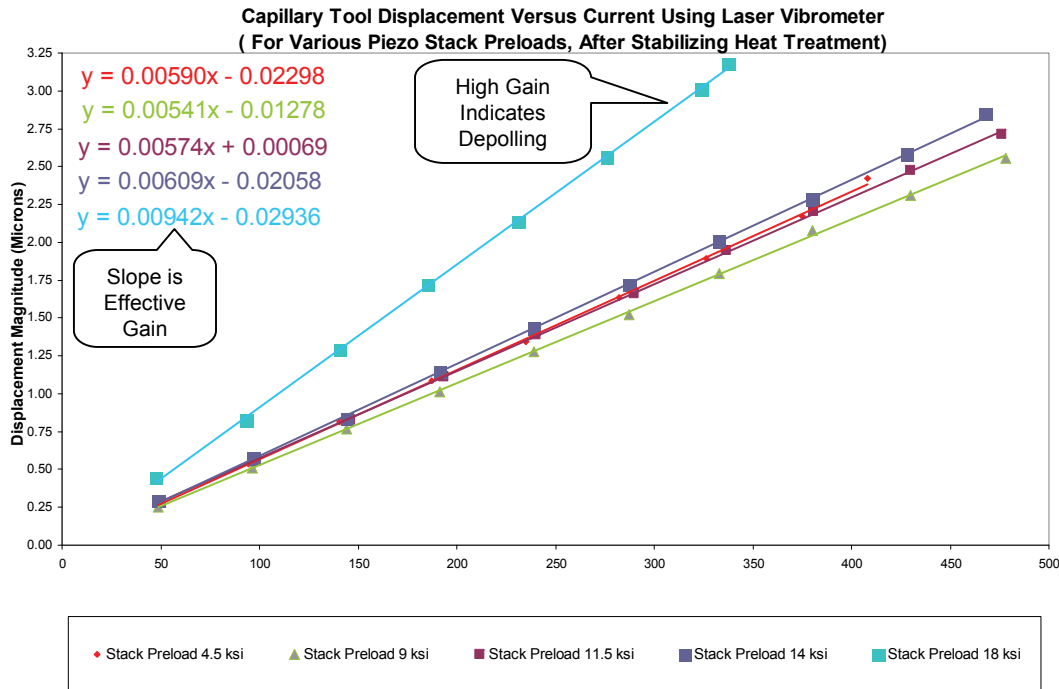
Bode Plot of Admittance (Y) Loop for Various Piezo Stack Preloads





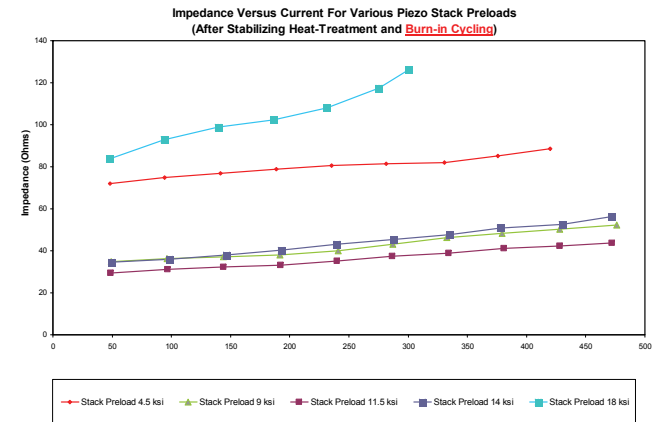
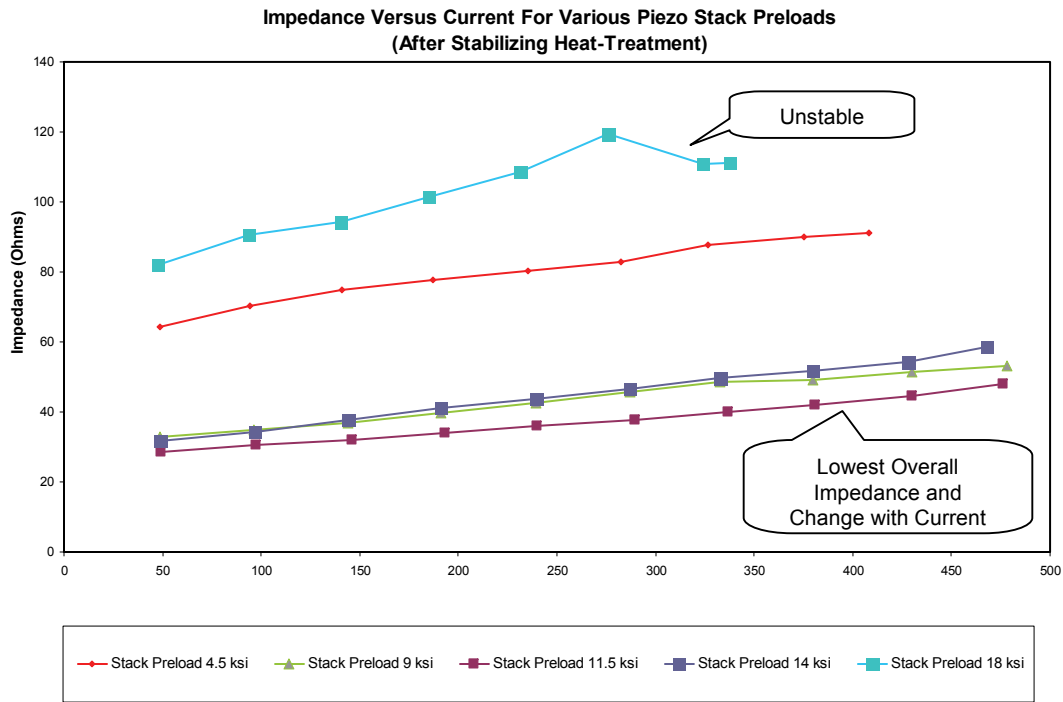
# EXPERIMENTAL RESULTS CON'T

## ❖ Tool Displacement to Current Gain Results After Stabilizing HT & Cycling



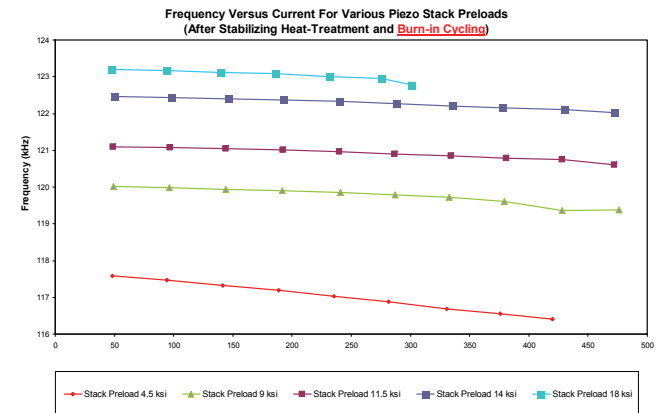
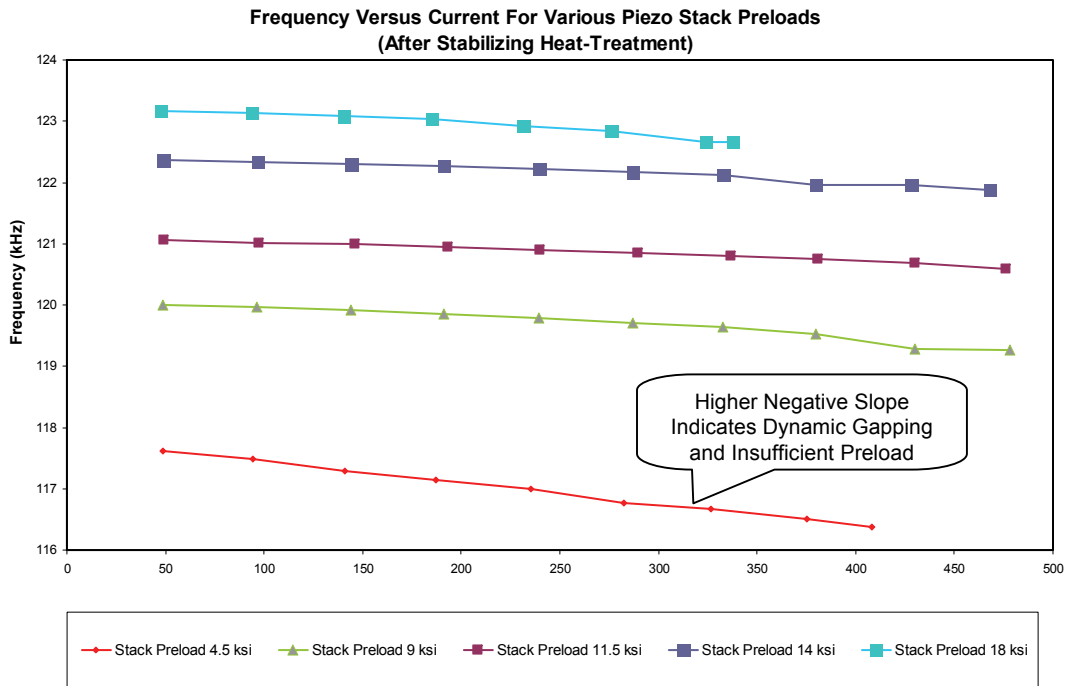
# EXPERIMENTAL RESULTS CON'T

## ❖ Impedance Vs. Current Results After Stabilizing Heat-Treatment & Cycling



# EXPERIMENTAL RESULTS CON'T

## ❖ Frequency Vs. Current Results After Stabilizing Heat-Treatment & Cycling





# CONCLUSIONS

- ❖ Optimal Preload Range for PZT8 Found From 9 to 14 ksi (11.5 ksi Best)
- ❖ Design Methodology Presented for Optimizing Transducer Preload
- ❖ Insufficient Preload Causes High Impedance and Dynamic Gapping
- ❖ Excessive Preload Causes Severe Depolling and High Impedance
- ❖ Stress Related Aging Affects Minimized at Higher Preloads
- ❖ New Preload Method Using Calibrated Stack Voltages Presented
- ❖ Bode Plot Method for Individual Crystals Presented



# REFERENCES

- ❖ Stansfield D., *Underwater Electroacoustic Transducers*, Peninsula Publishing, CA, 1991
- ❖ Wilson, O.B., *Introduction to Theory and Design of Sonar Transducers*, Peninsula Publishing, CA, 1991
- ❖ Sherman, C.H., Butler, J.L., *Transducers and Arrays for Underwater Sound*, Springer, NY, 2007



# QUESTIONS